

Features

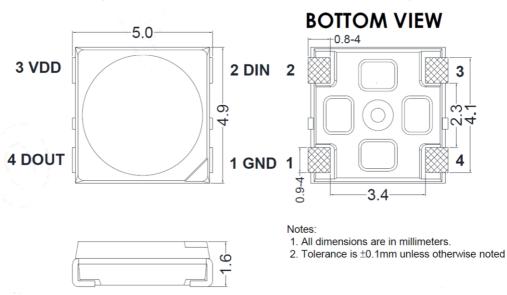
- 5050 with integrated high quality constant current IC and RGBW LED chips.
- Built-in IC, with high precision of constant current and internal RGBW chips spectral processing in advance.
- Single line data transmission (return to zero code).
- Specific Shaping Transmit Technology number of LED stacked is not restricted.
- Cascading Enhancement Technology any 2 LED spacing can be up to 10 meters.
- Data transfer rate of 800 kbp/s at 30 frames per second.
- RGBW output port PWM control can achieve 256 grey level adjustments.
- Upon powering up, IC performs self-inspection then lights connection on the pin B lamp.
- SA-I Anti-interference patent technology for single line data transmission.
- Built-in power supply reverse connect protection module, reversed power input will not damage the IC.

Description

The IN-PI55QATPRPGPBPW-XX is 5.0*5.0*1.6mm RGBW LED with integrated IC. It is a SMD type LED which can be used in various applications.

Applications

- Full color LED string light
- LED full color module
- LED guardrail tube
- LED scene lighting
- LED point light
- LED pixel screen
- LED shaped screen



Package Outline Dimensions & Pin Configuration

Figure 1. IN-PI55QATPRPGPBPW-XX Package Outline Dimensions



Pin Configuration

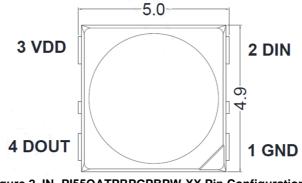


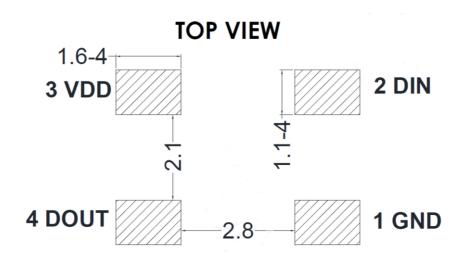
Figure 2. IN- PI55QATPRPGPBPW-XX Pin Configuration

Notes:

1. Dimension in millimeter, tolerance is ± 0.1 mm unless otherwise noted.

Number	Symbol	Function Description				
1	GND	Ground				
2	DIN	Control data signal input				
3	VDD	Power supply LED				
4	DOUT	Control data signal output				

Recommended dimensions for PCB products





Absolute Maximum Rating (Ta = 25 °C, VSS=0V)

Parameter	Symbol	Range	Unit
Power supply voltage	Vod	+3.7~+5.5	V
Logic input voltage	Vin	-0.5 ~VDD+0.5	V
Working temperature	Торт	-40 ~ +85	°C
Storage temperature	Тѕтд	-40 ~ +85	°C
ESD pressure(HBM)	Vesd	2K	V
ESD pressure(DM)	Vesd	200	V

LED Characteristics (Ta = 25°C)

Color	12mA					
Color	Wavelength(nm)	Light Intensity(mcd)				
Red	620-630	200-400				
Green	515-530	700-1000				
Blue	460-470	100-200				
Cool White	6000K	1500-2200				
Neutral White	4000k	1500-2200				
Warm White	3000k	1500-2200				



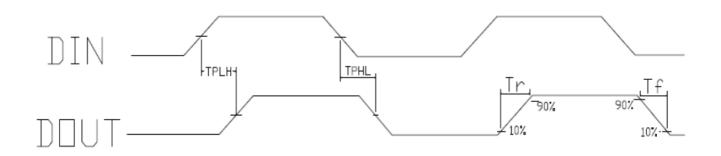
Recommended Operating Ranges (unless otherwise specified, Ta=-20 ~ +70 °C, VDD=4.5 ~ 5.5V, VSS=0V)

Parameter	Symbol	Min.	Тур.	Max	Unit	Test conditions
Supply voltage	V _{DD}	-	5.2	-	V	-
The signal input flip threshold	V _{IH}	0.7*VDD	-		V	VDD=5.0V
The signal input flip threshold	V _{IL}	-	-	0.3*VDD	V	VDD=5.0V
The frequency of PWM	F _{PWM}	-	1.2	-	KHZ	-
Static power consumption	I _{DD}	-	1	-	mA	-



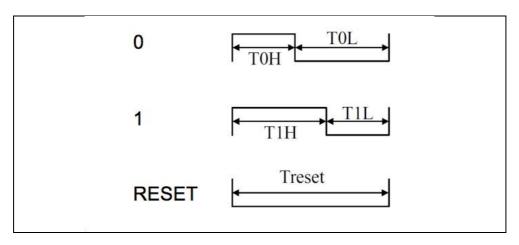
Switching Characteristics (unless otherwise specified, TA=25 °C)

Parameter	Symbol	Min.	Тур.	Max	Unit	Test conditions	
The speed of data transmission	fDIN	-	800	-	KHZ	The duty ratio of 67% (data 1)	
DOLIT transmission dolou	T _{PLH}	-	-	500	ns	DIN→DOUT	
DOUT transmission delay	T _{PHL}	-	-	500	ns		
	Tr	-	100	-	ns	VDS=1.5	
I _{OUT} Rise/Drop Time	Tf	-	100	-	ns	I _{OUT R/G/B} =8mA I _{OUT w} =16.5mA	



Timing Waveforms

1. Input Code

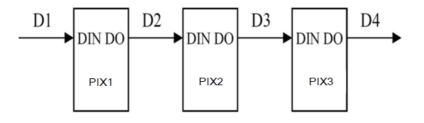




2. The data transmission time (TH+TL=1.25µs±600ns):

	Name	Min.	Standard value	Max.	Unit
Т	Code period	1.20			μs
тон	0 code, high level time	0.2 0.3 0		0.4	μs
TOL	0 code, low level time	0.8			μs
T1H	1 code, high level time	0.62	0.75	1.0	μs
T1L	1 code, low level time	0.2			μs
Trst	Reset code, low level time	>80		-	μs

3. Connection Scheme



4. Data Transfer Format

	1		r	eset cod >=80us	e		reset	code	
	- Dat	a refresh cyo	cle 1	-	Data refresh cycle 2				
D1	f i rst 32 bit	second 32 bit	third 32 bit	-	first 32 bit	second 32 bit	third 32 bit		
D2		second 32 bit	third 32 bit	-		second 32 bit	third 32 bit		
D3			third 32 bit	-			third 32 bit		
D4									

Note: the D1 sends data for MCU, D2, D3, D4 for data forwarding automatic shaping cascade circuit.

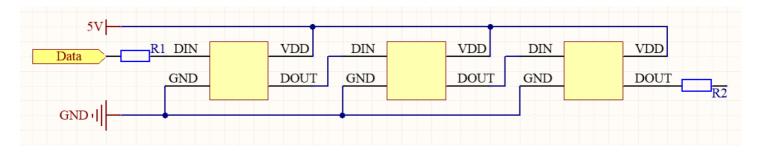
1110												
	G7	G6	G5	G4	G3	G2	G1	G0	R7	R6	R5	R4
	R3	R2	R1	RO	B7	B6	B5	B4	B3	B2	B1	BO
	W7	W6	W5	W4	W 3	W2	W1	WO				

5. The data structure of 32bit

Note: high starting, in order to send data (G7 - G6 -W0)



Typical Application Circuit



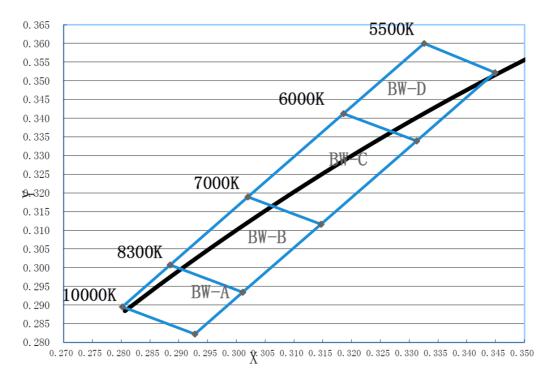
Product signal input and output must be connected in series with protection resistor R1. R1 depends on the size of the cascade amount, the greater the number of cascade, the smaller R1. The general recommended value is between $200-2K\Omega$, usually the recommended value is typical 500Ω .



Color Bin Specification

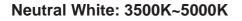
Name	Code	λd MIN (nm)	λd MAX (nm)
Ded	R1	620	625
Red	R2	625	630
Blue	B5	460	465
Diue	B6	465	470
	G2	515	520
Green	G3	520	525
	G4	525	530

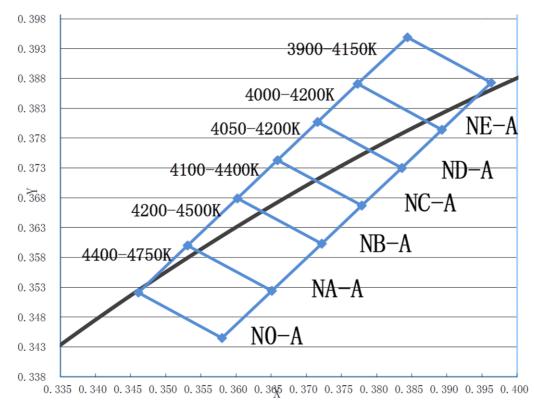
Cool White: 5000K~10000K



Name	X1	¥1	X2	¥2	ХЗ	¥3	X4	Y4
BW-A	0. 2928	0. 2822	0.2802	0. 2895	0. 2885	0. 3007	0.3011	0. 2934
BW-B	0.3011	0. 2934	0. 2885	0. 3007	0.302	0. 3189	0. 3147	0. 3116
BW-C	0.3147	0. 3116	0.302	0. 3189	0. 3186	0. 3412	0. 3313	0. 3339
BW-D	0. 3313	0. 3339	0. 3186	0. 3412	0. 3326	0.36	0. 3449	0. 3522



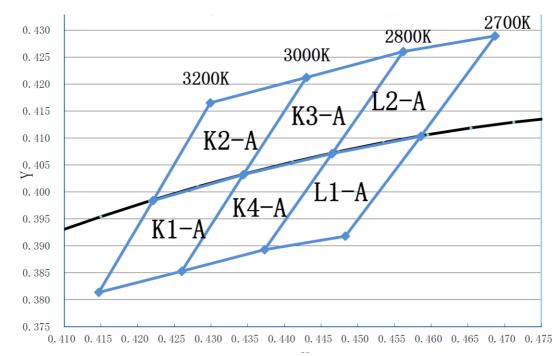




	X1	Y1	X2	Y2	Х3	ҮЗ	X4	¥4
NO-A	0.358	0.3445	0.3461	0.3521	0.3531	0.36	0.3651	0.3524
NA-A	0.3651	0.3524	0.3531	0.36	0.3602	0.3679	0.3722	0.3603
NB-A	0.3722	0.3603	0.3602	0.3679	0.3659	0.3743	0.3779	0.3667
NC-A	0.3779	0.3667	0.3659	0.3743	0.3716	0.3807	0.3836	0.373
ND-A	0.3836	0.373	0.3716	0.3807	0.3773	0.3871	0.3893	0.3794
NE-A	0.3893	0.3794	0.3773	0.3871	0.3844	0.3949	0.3963	0.3873



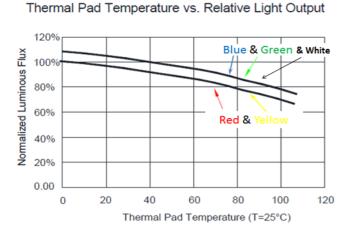




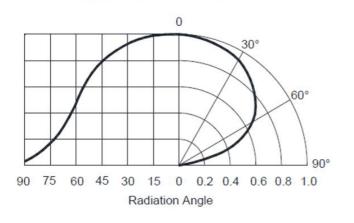
	X1	¥1	X2	¥2	Х3	¥З	X4	¥4
K1-A	0.4344	0.4032	0.4221	0.3984	0.4147	0.3814	0.426	0.3853
K2-A	0.443	0.4212	0.4299	0.4165	0.4221	0.3984	0.4344	0.4032
К3-А	0.4562	0.426	0.443	0.4212	0.4344	0.4032	0.4465	0.4071
K4-A	0.4465	0.4071	0.4344	0.4032	0.426	0.3853	0.4373	0.3893
L1-A	0.4586	0.4103	0.4465	0.4071	0.4373	0.3893	0.4483	0.3918
L2-A	0.4687	0.4289	0.4562	0.426	0.4465	0.4071	0.4586	0.4103



LED Performance Graph



Typical Radiation Pattern 120°



Wavelength Characteristics 100% RED GREEN Relative Emission Distribution BLUE 80% WS NW 60% BW 40% 20% 0.00 800 500 550 650 750 400 450 600 700 Wavelength (nm)

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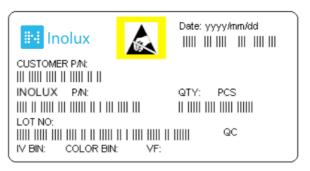


Ordering Information

Product	Emission Color	lv (mcd) Typ.	Wavelength (Wd) / CCT Typ.	Orderable Part Number			
	R	300	625				
IN-PI55QATPRPGPBPW-60	G	850	520	IN-PI55QATPRPGPBPW-60			
IN-PISSQATPRPGPBPVV-60	В	150	465	IN-PISSQATPRPGPBPW-60			
	W	1850	6000k				
	R	300	625				
IN-PI55QATPRPGPBPW-40	G	850	520	IN-PI55QATPRPGPBPW-40			
IN-PISSQATPRPGPBPVV-40	В	150	465	IN-PISSQATPRPGPBPW-40			
	W	1850	4000k				
	R	300	625				
IN-PI55QATPRPGPBPW-30	G	850	520	IN-PI55QATPRPGPBPW-30			
IN-PIDDQATPRPGPBPW-30	В	150	465				
	W	1850	3000k				



Label Specifications



Inolux P/N:

I		Ν	PI	-	55	Q	А	Т	(X)		-	XX	-	Х	Х	Х	Х
			Product		Package	Die Qty.	Variation	Orientation	Current	Color		Color Temperature of White				mized ıp-off	
In	olu>	x	PI- Single trace IC PC- Clock Function IC		55QA =	55QA = 5.0 x 5.0 x 1.6 mm		T = Top Mount	P=12mA 5 = 5mA	R = 624nm G = 520nm B = 470nm W = 2700K-7000K		60: Cool White 40: Neutral White 30: Warm White					

Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voor (2017	2019 \	Month	Data	Sorial	
Tracker		Year (2017	, 2018,)	WOITT	Date	Serial	



Precautions

Please read the following notes before using the product:

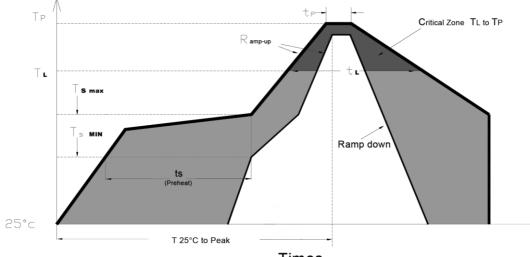
1. Storage

- 1.1 Do not open moisture proof bag before the products are ready to use.
- 1.2 Before opening the package, the LEDs should be kept at 30 $^\circ\!{\rm C}$ or less and 80%RH or less.
- 1.3 The LEDs should be used within a year.
- 1.4 After opening the package, the remaining LEDs should be kept in a resealed bag.
- 1.5 The LEDs require mandatory baking before usage. Baking treatment listed below.
- 1.6 If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

*Baking treatment: $60\pm5^{\circ}$ C for 24 hours.



2. Soldering Condition Recommended soldering conditions:



Times

Profile Feature	Lead-Free Solder				
Average Ramp-Up Rate (Ts _{max} to Tp)	3°C/second max.				
Preheat: Temperature Min (Ts _{min})	150 ℃				
Preheat: Temperature Min (Ts _{max})	200 °⊂				
Preheat: Time(ts _{min to} ts _{max})	60-180 seconds				
Time Maintained Above: Temperature (TL)	217 ℃				
Time Maintained Above: Time (t $_{L}$)	60-150 seconds				
Peak/Classification Temperature (T P)	240 ℃				
Time Within 5°C of Actual Peak Temperature (tp)	<10 seconds				
Ramp-Down Rate	6°C/second max.				
Time 25 $^\circ\!\!C$ to Peak Temperature	<6 minutes max.				

Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.

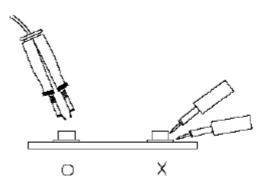


3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260° C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

4. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



5. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wristband or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.



Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	05-31-2018
Format adjustment		1.1	07-01-2018
Format adjustment		1.2	08-06-2018
Revise precautions	14	1.3	07-31-2019
Revies the drawing and spec.	1-10	1.4	02-04-2021

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